



SMD Auto X8G HT150C, Ceramic, 0.022 uF, 2%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 1210, 1.5 mm



General Information		
Series	SMD Auto X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade	
Features	High Temperature, Ultra-Stable, Automotive Grade	
RoHS	Yes	
Termination	Tin	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Typical Component Weight	40 mg	
Shelf Life	78 Weeks	
MSL	1	

0.022 uF

45.4545 GOhms

Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
Т	1.1mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

••	2.0 / 0.2
T	1.1mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

Packaging

Packaging Quantity

	3.2mm +/-0.2mm	Measurement Condition	1 kHz 1.0Vrms
	2.5mm +/-0.2mm	Tolerance	2%
	1.1mm +/-0.10mm	Voltage DC	200 VDC
	1.5mm MIN	Dielectric Withstanding Voltage	500 VDC
	0.5mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
ations		Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
	2500	Dissipation Factor	0.1% 1 kHz 1.0Vrms
		Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours

Insulation Resistance

Specifications Capacitance

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